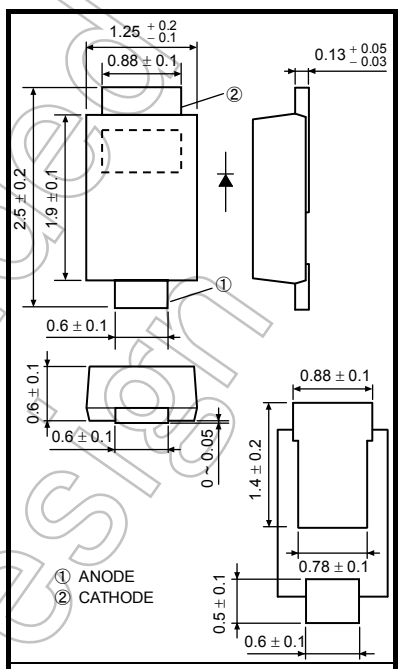
TOSHIBA Schottky Barrier Rectifier Schottky Barrier Type

CUS10I30A

Secondary Rectification in Switching Regulators
Reverse-Current Protection in Mobile Devices

- Forward voltage: V_{FM} = 0.39 V (max) @ I_{FM} = 0.7 A
- Forward current (AV): $I_{F\ (AV)}$ = 1.0 A
- Repetitive peak reverse voltage: V_{RRM} = 30 V
- Suitable for high-density board assembly due to the use of a small surface-mount package, "US-FLAT™"

Unit: mm



JEDEC	—
JEITA	—
TOSHIBA	3-2B1A

Weight: 0.004 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}	30	V
Forward current (AV)	$I_{F\ (AV)}$	1.0 (Note 1)	A
Peak one-cycle surge current	I_{FSM}	20 (50 Hz)	A
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ta = 44°C: Device mounted on a glass-epoxy board
Board size: 50 mm × 50 mm
Soldering size: 6 mm × 6 mm
Board thickness: 1.6 mm
Rectangular waveform (α = 180°), V_R = 15 V

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Start of commercial production
2009-11

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM\ (1)}$	I_{FM} = 0.1 A (pulse test)	—	0.27	—	V
	$V_{FM\ (2)}$	I_{FM} = 0.7 A (pulse test)	—	0.35	0.39	
	$V_{FM\ (3)}$	I_{FM} = 1.0 A (pulse test)	—	0.37	—	
Repetitive peak reverse current	$I_{RRM\ (1)}$	V_{RRM} = 5.0 V (pulse test)	—	10	—	μA
	$I_{RRM\ (2)}$	V_{RRM} = 30 V (pulse test)	—	20	60	
Junction capacitance	C_j	V_R = 10 V, f = 1.0 MHz	—	50	—	pF
Thermal resistance (junction to ambient)	$R_{th\ (j\text{-}a)}$	Device mounted on a ceramic board board size: 50 mm × 50 mm soldering land: 2 mm × 2 mm board thickness: 0.64 mm	—	—	75	°C/W
		Device mounted on a glass-epoxy board board size: 50 mm × 50 mm soldering land: 6 mm × 6 mm board thickness: 1.6 mm	—	—	150	
Thermal resistance (junction to lead)	$R_{th\ (j\text{-}\ell)}$	—	—	—	30	°C/W

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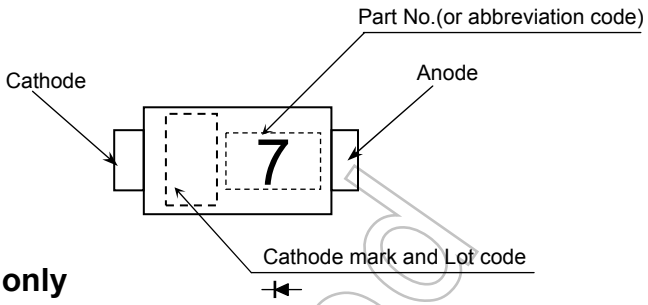
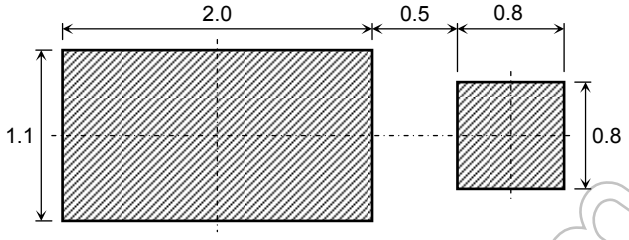
Marking

Abbreviation Code	Part No.
7	CUS10I30A



Land pattern dimensions for reference only

Unit: mm



Handling Precaution

Schottky barrier diodes have reverse current characteristics compared to other diodes.
There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage.
Please take forward and reverse loss into consideration during design.

The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded,even for a moment. Do not exceed any of these ratings. The following are the general derating methods that we recommend when you design a circuit with a device.

V_{RRM}: Use this rating with reference to the above. V_{RRM} has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.

$I_{F(AV)}$: We recommend that the worst case current be no greater than 80% of the absolute maximum rating of $I_{F(AV)}$ and T_j be below 120°C. When using this device, take the margin into consideration by using an allowable Ta max-$I_{F(AV)}$ curve.

I_{FSM}: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.

T_j: Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_j of below 120°C.

Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.

Please refer to the Rectifiers databook for further information.

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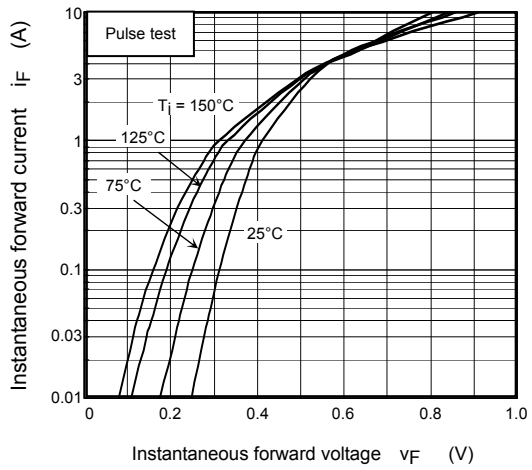
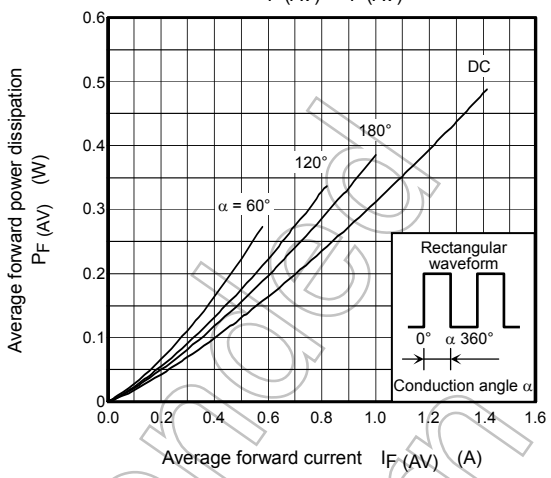
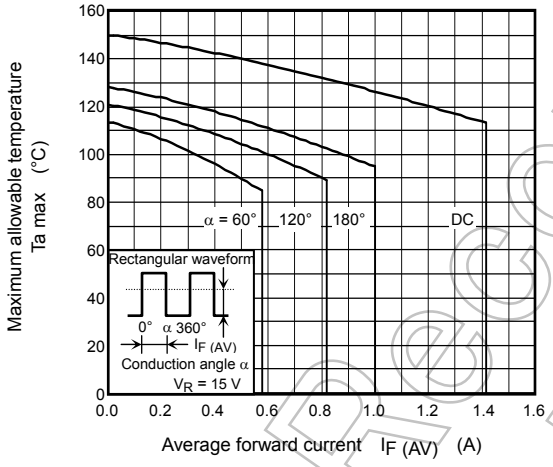
$i_F - v_F$



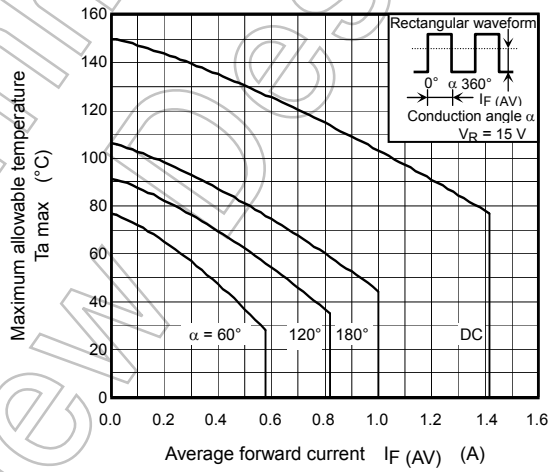
$P_{F\ (AV)} - I_{F\ (AV)}$



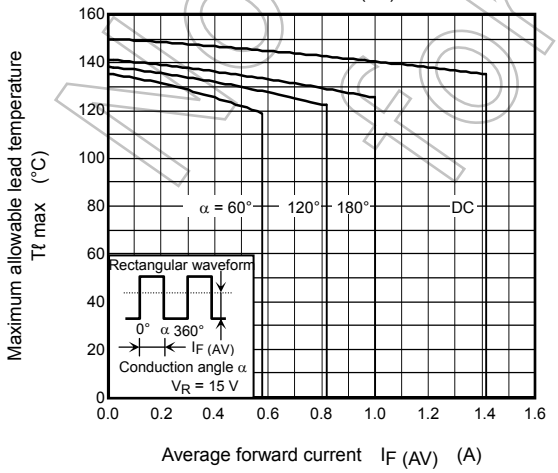
Ta max – $I_{F\ (AV)}$
Ceramic substrate (substrate size:
50 mm × 50 mm, soldering land: 2 mm × 2 mm)



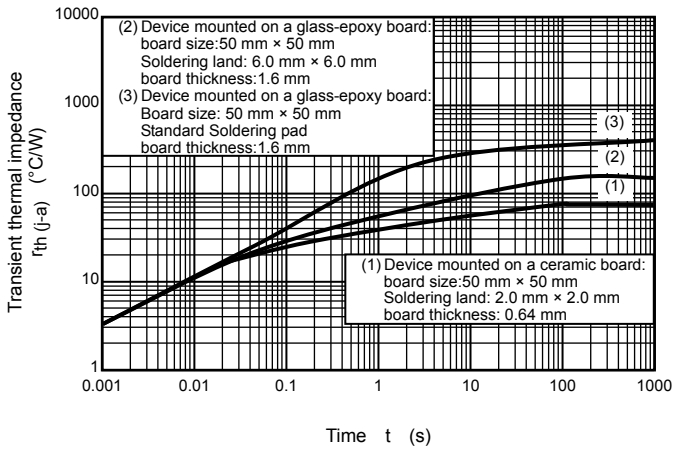
Ta max – $I_{F\ (AV)}$
Glass-epoxy substrate (substrate size:
50 mm × 50 mm, soldering land: 6 mm × 6 mm)



Tℓ max – $I_{F\ (AV)}$



$r_{th\ (j\text{-}a)} - t$



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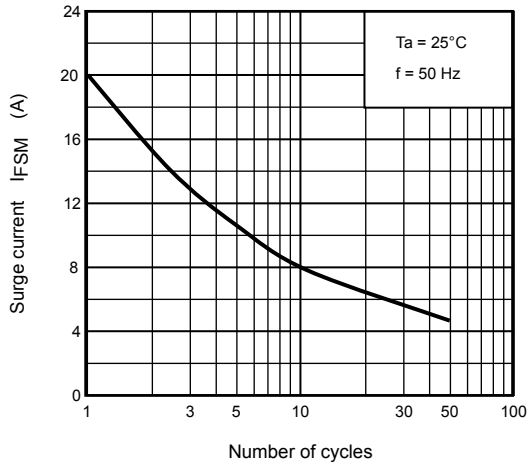
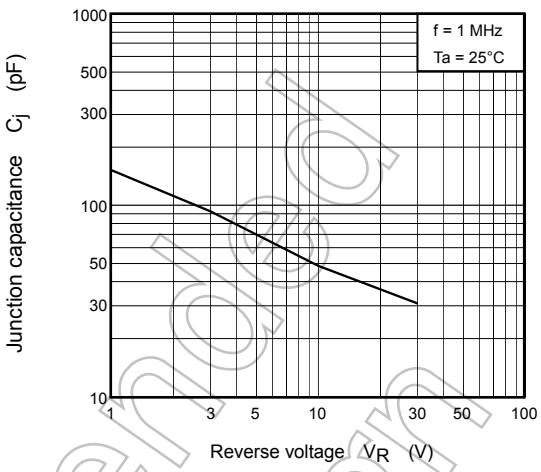
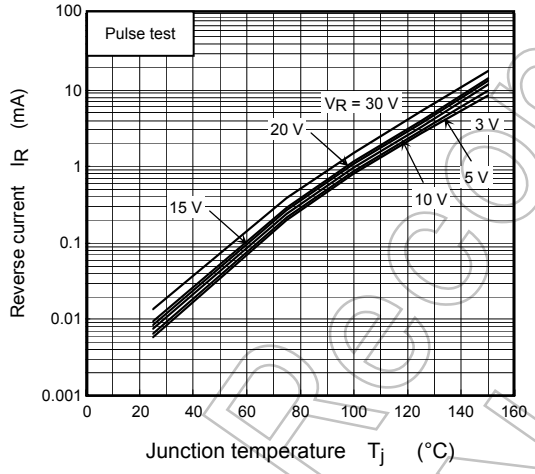
Surge current



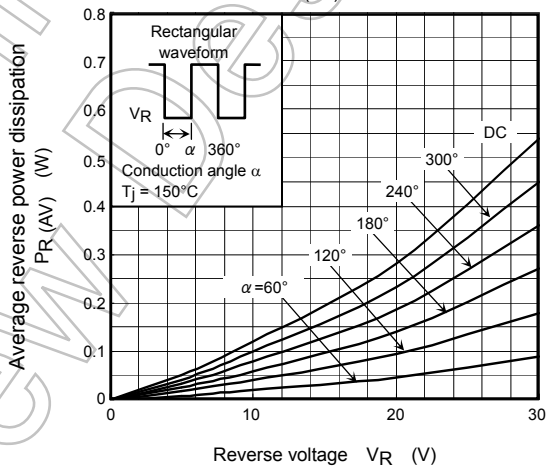
$C_j - V_R$ (typ.)



$I_R - T_j$ (typ.)



$P_{R\ (AV)} - V_R$ (typ.)



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